

ROHS

HALOGEN FREE

Hyperfast Rectifier, 30 A FRED Pt® G5



LINKS TO ADDITIONAL RESOURCES





PRIMARY CHARACTERISTICS						
I _{F(AV)}	30 A					
V _R	600 V					
V _F at I _F at 125 °C	1.3 V					
t _{rr} (typ.)	22					
I _{FSM}	310					
T _J max.	175 °C					
Package	TO-247AD 3L					
Circuit configuration	Single					

FEATURES

- Hyperfast and optimized Q_{rr}
- Best in class forward voltage drop and switching losses trade off



• 175 °C maximum operating junction temperature

- Polyimide passivation
- AEC-Q101 qualified meets JESD 201 whisker test 2
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV on-board battery chargers

MECHANICAL DATA

Case: TO-247AD 3L

Molding compound meets UL 94 V-0 flammability rating **Terminal:** matte tin plated leads, solderable per J-STD-002

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Repetitive peak reverse voltage	V_{RRM}		600	V			
Average rectified forward current	I _{F(AV)}	T _C = 117 °C, D = 0.50	30				
Non-repetitive peak surge current	I _{FSM}	T_C = 25 °C, t_p = 10 ms, sine wave both anodes, (1) and (3) connected	310	Α			
Repetitive peak forward current	I _{FRM}	T _C = 117 °C, D = 0.50, f = 20 kHz	60				
Operating junction and storage temperature	T_J , T_{Stg}		-55 to +175	°C			

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	V_{BR}, V_{R}	$I_R = 100 \mu A$	600	-	-		
Forward voltage	V	I _F = 30 A	-	1.6	2.1	V	
	V _F	I _F = 30 A, T _J = 125 °C	-	1.3	-		
Payaraa laakaga aurrant	I _R	$V_R = V_R$ rated	-	-	20		
Reverse leakage current		T _J = 125 °C, V _R = V _R rated	-	-	500	μA	
Junction capacitance	C _T	V _R = 200 V	-	36	=.	pF	
Series inductance	L _S	Measured to lead 5 mm from package body	-	8	-	nΗ	



DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1.0 \text{ A}, dI_F/dt = 10$	0 A/μs, V _R = 30 V	-	22	-	
Reverse recovery time	t _{rr}	T _J = 25 °C		-	39	=.	ns
		T _J = 125 °C		-	50	-	
Dook recovery ourrent	ı	T _J = 25 °C	$I_F = 20 \text{ A}$	-	14	-	А
Peak recovery current	I _{RRM}	T _J = 125 °C	dI _F /dt = 1000 A/μs V _R = 400 V	-	24	=.	
Dovorno rocoveni chargo		T _J = 25 °C		-	253	=.	nC
Reverse recovery charge	Q _{rr}	T _J = 125 °C		=	785	-	
Dovorce recovery time	+	T _J = 25 °C	I _F = 30 A dI _F /dt = 1000 A/μs V _B = 400 V	-	41	-	ns
Reverse recovery time	t _{rr}	T _J = 125 °C		-	56	-	
Dools recovery overent		T _J = 25 °C		=	16	-	^
Peak recovery current	I _{RRM}	T _J = 125 °C		-	27	-	Α
Reverse recovery charge		T _J = 25 °C	""	-	306	-	nC
	Q _{rr}	T _J = 125 °C			952	-	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Thermal resistance, junction-to-case	R _{thJC}		-	-	1.1	°C/W	
Weight			-	5.5	-	g	
Mounting torque			6 (5)	-	12 (10)	kgf · cm (lbf · in)	
Maximum junction and storage temperature range	T _J , T _{Stg}		-55	-	175	°C	
Marking device		Case style: TO-247AD 3L	A5PX3006LH				

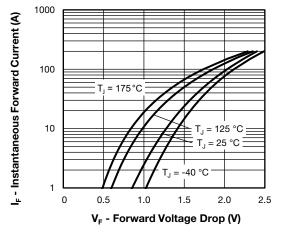


Fig. 1 - Typical Forward Voltage Drop Characteristics

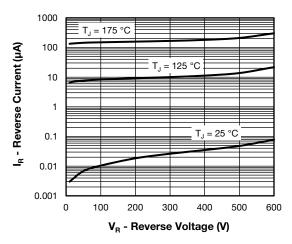


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



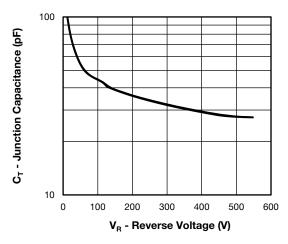


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

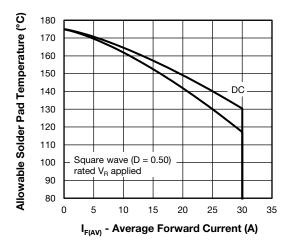


Fig. 4 - Maximum Allowable Case Temperature vs.
Average Forward Current

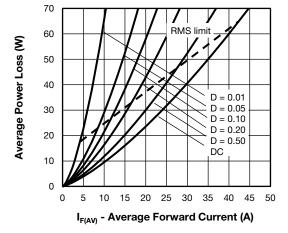


Fig. 5 - Average Power Loss vs. Average Forward Current

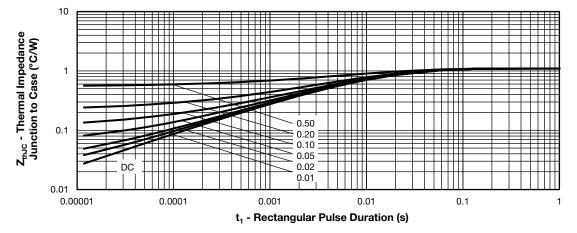


Fig. 6 - Thermal Impedance Z_{thJC} - Characteristics



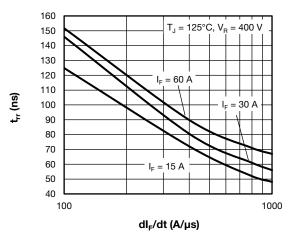


Fig. 7 - Typical Reverse Recovery Time vs. dI_E/dt

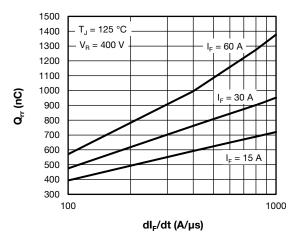


Fig. 8 - Typical Reverse Recovery Charge vs. dl_F/dt

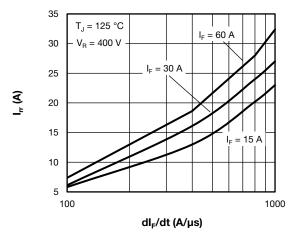


Fig. 9 - Typical Reverse Recovery Current vs. dl_F/dt

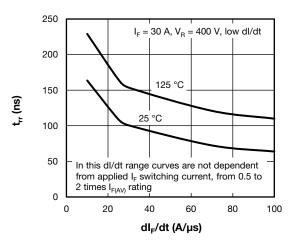


Fig. 10 - Typical Reverse Recovery Time vs. dl_F/dt

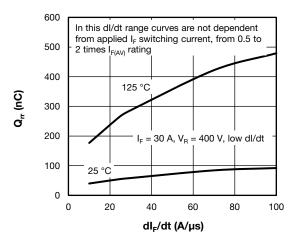


Fig. 11 - Typical Reverse Recovery Charge vs. dl_F/dt

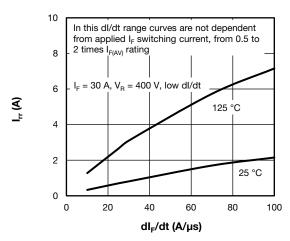


Fig. 12 - Typical Reverse Recovery Current vs. dl_F/dt

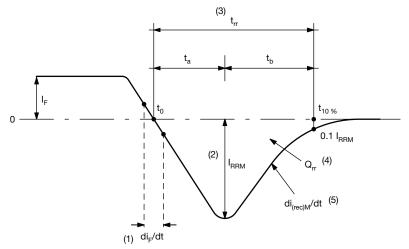


Fig. 13 - Reverse Recovery Waveform and Definitions

Notes

- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from t_0 , crossing point of negative going I_F , to point $t_{10\%}$, 0.1 I_{RRM}
- $^{(4)}$ Q_{rr} area under curve defined by t_0 and t_{10} %

$$Q_{rr} = \int_{t_0}^{\tau_{10\%}} I(t) dt$$

(5) di_(rec)M/dt - peak rate of change of current during t_b portion of t_{rr}

ORDERING INFORMATION TABLE

Device code VS-5 Ρ X 30 06 **N3** Α Н L 2 (9) $\begin{pmatrix} 1 \\ 4 \end{pmatrix}$ (10)(3) (5) 6 8 Vishay Semiconductors product 2 Circuit configuration A = single diode, 2 anodes FRED Pt® Gen 5 P = TO-247 package Process type: X = hyperfast recovery Current rating (30 = 30 A)7 Voltage rating (06 = 600 V) 8 Package: L = long lead (TO-247AD) H = AEC-Q101 qualified Environmental digit:

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-A5PX3006LHN3	25	500	Antistatic plastic tube				

N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95626				
Part marking information	www.vishay.com/doc?95007				



TO-247AD 3L

DIMENSIONS in millimeters and inches



View B

	MILLIMETERS INCHES					
SYMBOL	IVIILLIIV	IETEKS	INC	пЕЭ	NOTES	
01111202	MIN.	MAX.	MIN.	MAX.		
Α	4.65	5.31	0.183	0.209		
A1	2.21	2.59	0.087	0.102		
A2	1.50	2.49	0.059	0.098		
b	0.99	1.40	0.039	0.055		
b1	0.99	1.35	0.039	0.053		
b2	1.65	2.39	0.065	0.094		
b3	1.65	2.34	0.065	0.092		
b4	2.59	3.43	0.102	0.135		
b5	2.59	3.38	0.102	0.133		
С	0.38	0.89	0.015	0.035		
c1	0.38	0.84	0.015	0.033		
D	19.71	20.70	0.776	0.815	3	
D1	13.08	-	0.515	-	4	

Section C - C, D - D, E - E

SYMBOL	MILLIMETERS		INC	NOTES	
STIVIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØΚ	0.2	0.254		0.010	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217	BSC	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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